

1761

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

AUWETER et al.

Serial No. 09/929,075

Filed: August 15, 2001

For: SOLID PREPARATIONS HAVING A MULTICORE STRUCTURE



RECEIVED

JAN 11 2002

TC 1700

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Commissioner of Patents and Trademarks, Washington, D.C. 20231, on: October 25, 2001

Date of Deposit Herbent B. Keil
Person Making Deposit Herbent B. Keil
Signature Herbent B. Keil October 25, 2001

Date of Signature

Hon. Commissioner of Patents
and Trademarks
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Sir:

This subject Information Disclosure Statement is submitted in connection with applicants' continuing duty of disclosure under 37 CFR 1.56.

Listing of Relevant Documents

The relevant documents are listed in the attached Form PTO-1449.

Remarks

The listed references are discussed in the specification on pages 1, 2, 5 and 7-9.

English equivalents are provided as follows:

US 4,522,743 = EP 065 193;
US 5,364,563 = EP 410 236; and
CA 2274467 = WO 98/26008.

EP-B 065193 is not available in English, however, the reference is discussed in the specification on pages 7 and 9, which should meet the "concise explanation" requirement for non-English documents.

Respectfully submitted,
KEIL & WEINKAUF


Herbent B. Keil
Reg. No. 18,967

1101 Connecticut Avenue, N.W.
Washington, D.C. 20036
(202) 659-0100
HBK/kas